

IEEE 半导体行业快报

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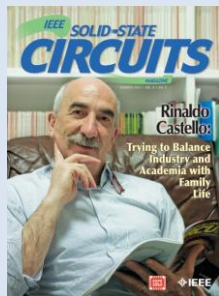
2014 年第 4 期,总第 4 期

行业新闻

- PVU, ILMT, LPAR, IPAA and IPLA -- IBM's licensing jargon decoded - BetaNews
- Why buy Intel's Broadwell chip, with Skylake waiting in the wings? - PCWorld
- IBM cuts pay by 10% for workers picked for training - Computerworld
- Interesting January 2017 Stock Options for IBM - Forbes
- Can IBM Launch Apple's Enterprise? - Seeking Alpha (registration)
- Samsung Galaxy Tab S Review: Setting The Android Standard [VIDEO] - International Business Times
- Why buy Intel's Broadwell chip, with Skylake waiting in the wings? - PCWorld
- Selfie-obsessed Samsung Galaxy Grand Prime leaks - GSMArena.com
- Install Android 4.4.4 KitKat Update Samsung Galaxy Note 3 on Sprint, Available ... -Christian Post
- Samsung Pokes Fun At Self In Latest Apple Attack Ad - Wall Street Journal (blog)

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热点期刊论文 （本期为您推荐 IEEE Solid-State Magazine）



- Development of Self-Calibrating A/D Converters
- Early development of mixed-signal MOS circuit technology
- Through the Looking Glass Continued (III): Update to Trends in Solid-State Circuits and Systems from ISSCC 2014 [ISSCC Trends]
- Designing Analog MOS Circuits at Berkeley in the Mid-70s
- The UC Berkeley IC Lab
- Inductors and Transformers: Enabling the Gigahertz Silicon IC Revolution

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热点会议论文 （本期为您推荐 2013 IEEE Custom Integrated Circuits Conference）



- Interconnect and package design of a heterogeneous stacked-silicon FPGA
- A 5 Gb/s 3.2 mW/Gb/s 28 dB loss-compensating pulse-width modulated voltage-mode transmitter
- Current-steering pre-emphasis transmitter with continuously tuned line terminations for optimum impedance match and maximum signal drive range
- Design techniques for CMOS backplane transceivers approaching 30-Gb/s data rates
- Compact high-power 60 GHz power amplifier in 65 nm CMOS

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